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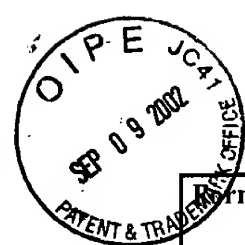
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Respectfully submitted,
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Information Disclosure Statement By Applicant	Applicant: Umair A. Khan et al.	
(Use Several Sheets if Necessary)	Filing Date: July 13, 2001	Group Art Unit: 2155

U.S. Patent Documents

Examiner Initial	No.	Publication No.	Date	Patentee	Class	Sub-class	Filing Date
	A	US 2001/0034734 A1	10/25/01	Whitley et al.	707	104.1	02/09/01
	B	US 2002/0032782 A1	03/14/02	Rangan et al.	709	229	12/08/98
	C	US 2001/0037355 A1	11/01/01	Britt, JR.	709	201	03/09/01
	D	US 2002/0023230 A1	02/21/02	Bolnick et al.	713	202	04/11/01
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Other Documents

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